



Data sheet acquired from Harris Semiconductor
SCHS087

CMOS Dual Binary to 1 of 4 Decoder/Demultiplexers

High-Voltage Types (20-Volt Rating)

CD4555B: Outputs High on Select

CD4556B: Outputs Low on Select

■ CD4555B and CD4556B are dual one-of-four decoders/demultiplexers. Each decoder has two select inputs (A and B), an Enable input (\bar{E}), and four mutually exclusive outputs. On the CD4555B the outputs are high on select; on the CD4556B the outputs are low on select.

When the Enable input is high, the outputs of the CD4555B remain low and the outputs of the CD4556B remain high regardless of the state of the select inputs A and B. The CD4555B and CD4556B are similar to types MC14555 and MC14556, respectively.

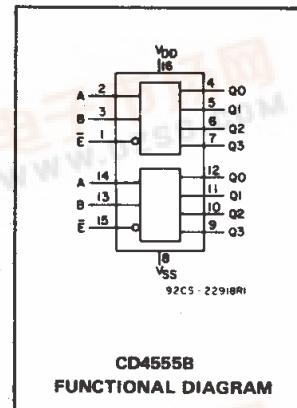
The CD4555B and CD4556B types are supplied in 16-lead hermetic dual-in-line ceramic packages (D and F suffixes), 16-lead dual-in-line plastic packages (E suffix), and in chip form (H suffix).

Features:

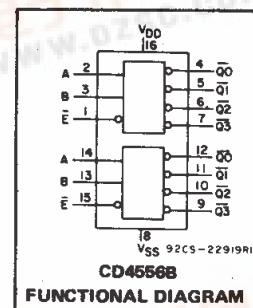
- Expandable with multiple packages
- Standard, symmetrical output characteristics
- 100% tested for quiescent current at 20 V
- Maximum input current of 1 μ A at 18 V over full package temperature range; 100 nA at 18 V and 25°C
- Noise margin (full package-temperature range): 1 V at $V_{DD} = 5$ V
2 V at $V_{DD} = 10$ V
2.5 V at $V_{DD} = 15$ V
- 5-V, 10-V, and 15-V parametric ratings
- Meets all requirements of JEDEC Tentative Standard No. 13B, "Standard Specifications for Description of 'B' Series CMOS Devices"

Applications:

- Decoding ■ Code conversion
- Demultiplexing (using Enable input as a data input)
- Memory chip-enable selection
- Function selection



CD4555B
FUNCTIONAL DIAGRAM



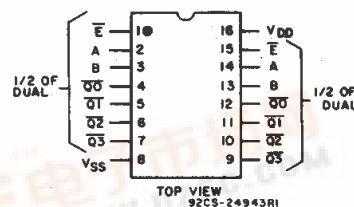
CD4556B
FUNCTIONAL DIAGRAM

RECOMMENDED OPERATING CONDITIONS

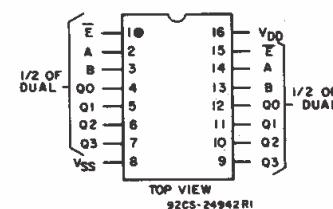
For maximum reliability, nominal operating conditions should be selected so that operation is always within the following ranges.

CHARACTERISTIC	V_{DD}	MIN.	MAX.	UNITS
Supply Voltage Range (For $T_A = \text{Full Package Temp. Range}$)	-	3	18	V

TERMINAL ASSIGNMENTS



CD4556B



CD4555B

MAXIMUM RATINGS, Absolute-Maximum Values:

DC SUPPLY-VOLTAGE RANGE, (V_{DD})

Voltages referenced to V_{SS} Terminal) -0.5V to +20V

INPUT VOLTAGE RANGE, ALL INPUTS -0.5V to V_{DD} +0.5V

DC INPUT CURRENT, ANY ONE INPUT ± 10 mA

POWER DISSIPATION PER PACKAGE (PD):

For $T_A = -55^\circ\text{C}$ to $+100^\circ\text{C}$ 500mW

For $T_A = +100^\circ\text{C}$ to $+125^\circ\text{C}$ Derate Linearity at 12mW/ $^\circ\text{C}$ to 200mW

DEVICE DISSIPATION PER OUTPUT TRANSISTOR

FOR $T_A = \text{FULL PACKAGE-TEMPERATURE RANGE (All Package Types)}$ 100mW

OPERATING-TEMPERATURE RANGE (T_A) -55°C to +125°C

STORAGE TEMPERATURE RANGE (T_{stg}) -65°C to +150°C

LEAD TEMPERATURE (DURING SOLDERING):

At distance $1/16 \pm 1/32$ inch (1.59 ± 0.79 mm) from case for 10s max +265°C

CD4555B, CD4556B Types

STATIC ELECTRICAL CHARACTERISTICS

CHARACTERISTIC	CONDITIONS			LIMITS AT INDICATED TEMPERATURES (°C)						UNITS
				-55	-40	+85	+125	+25		
	V _O (V)	V _{IN} (V)	V _{DD} (V)	Min.	Typ.	Max.		Min.	Typ.	
Quiescent Device Current, I _{DD} Max.	—	0.5	5	5	5	150	150	—	0.04	5
	—	0.10	10	10	10	300	300	—	0.04	10
	—	0.15	15	20	20	600	600	—	0.04	20
	—	0.20	20	100	100	3000	3000	—	0.08	100
Output Low (Sink) Current, I _{OL} Min.	0.4	0.5	5	0.64	0.61	0.42	0.36	0.51	1	—
	—	0.10	10	1.6	1.5	1.1	0.9	1.3	2.6	—
	—	0.15	15	4.2	4	2.8	2.4	3.4	6.8	—
	—	0.15	15	—4.2	—4	—2.8	—2.4	—3.4	—6.8	—
Output High (Source) Current, I _{OH} Min.	—4.6	0.5	5	—0.64	—0.61	—0.42	—0.36	—0.51	—1	—
	—	0.10	10	—2	—1.8	—1.3	—1.15	—1.6	—3.2	—
	—	0.10	10	—1.6	—1.5	—1.1	—0.9	—1.3	—2.6	—
	—	0.15	15	—4.2	—4	—2.8	—2.4	—3.4	—6.8	—
Output Voltage: Low-Level, VOL Max.	—	0.5	5	0.05			—	0	0.05	—
	—	0.10	10	0.05			—	0	0.05	—
	—	0.15	15	0.05			—	0	0.05	—
Output Voltage: High-Level, VOH Min.	—	0.5	5	4.95			4.95	5	—	—
	—	0.10	10	9.95			9.95	10	—	—
	—	0.15	15	14.95			14.95	15	—	—
Input Low Voltage, V _{IL} Max.	0.5, 4.5	—	5	1.5			—	—	1.5	—
	—	1.9	—	10	3			—	—	3
	—	1.5, 13.5	—	15	4			—	—	4
Input High Voltage, V _{IH} Min.	0.5, 4.5	—	5	3.5			3.5	—	—	—
	—	1.9	—	10	7			7	—	—
	—	1.5, 13.5	—	15	11			11	—	—
Input Current I _{IN} Max.		0.18	18	±0.1	±0.1	±1	±1	—	±10 ⁻⁵	±0.1

DYNAMIC ELECTRICAL CHARACTERISTICS at $T_A = 25^\circ\text{C}$; Input $t_p, t_f = 20\text{ ns}$, $C_L = 50\text{ pF}$, $R_L = 200\text{ k}\Omega$

CHARACTERISTIC	TEST CONDITIONS			LIMITS		UNITS	
				V _{DD} Volts	TYP.		
Propagation Delay Time, t _{PHL} , A or B Input to Any Output				5	220	440	ns
				10	95	190	
				15	70	140	
E Input to Any Output				5	200	400	ns
				10	85	170	
				15	65	130	
Transition Time t _{THL} , t _{TLH}				5	100	200	ns
				10	50	100	
				15	40	80	
Input Capacitance C _{IN}	Any Input			5	7.5	pF	

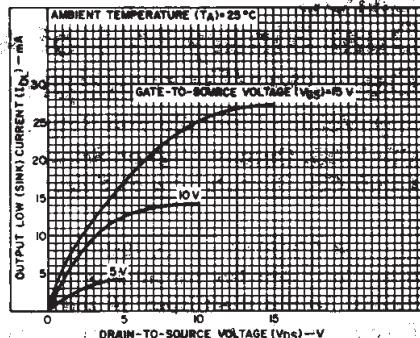


Fig. 1 — Typical output low (sink) current characteristics.

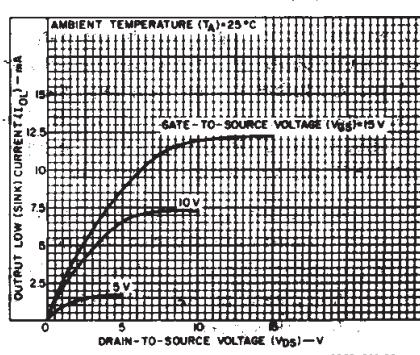


Fig. 2 — Minimum output low (sink) current characteristics.

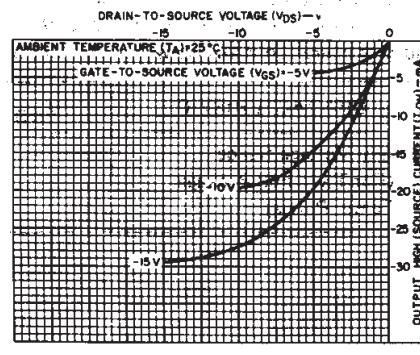


Fig. 3 — Typical output high (source) current characteristics.

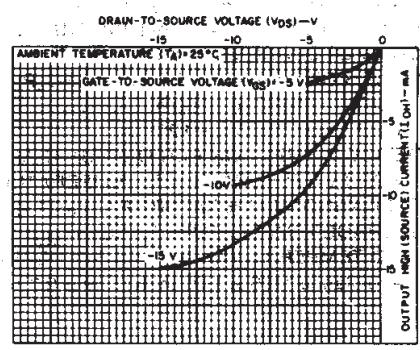
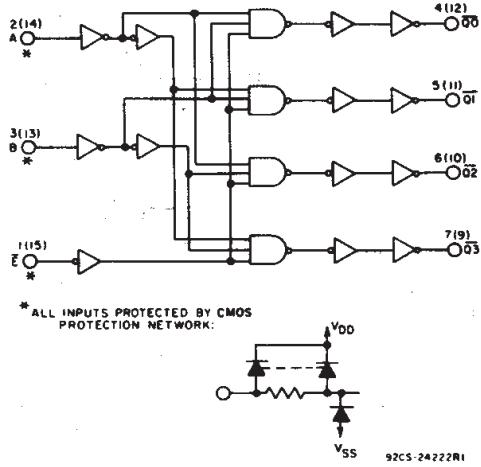
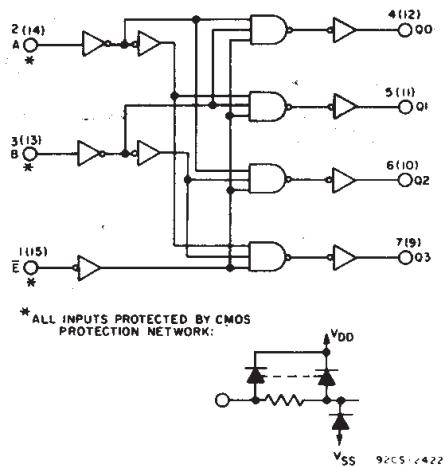


Fig. 4 — Minimum output high (source) current characteristics.

CD4555B, CD4556B TypesFig. 5 – CD4556B logic diagram
(1 of 2 identical circuits).Fig. 6 – CD4555B logic diagram
(1 of 2 identical circuits).**TRUTH TABLE**

INPUTS ENABLE SELECT			OUTPUTS CD4555B				OUTPUTS CD4556B			
\bar{E}	B	A	Q3	Q2	Q1	Q0	Q3	Q2	Q1	Q0
0	0	0	0	0	0	1	1	1	1	0
0	0	1	0	0	1	0	1	1	0	1
0	1	0	0	1	0	0	1	0	1	1
0	1	1	1	0	0	0	0	1	1	1
1	X	X	0	0	0	0	1	1	1	1

X = DON'T CARE

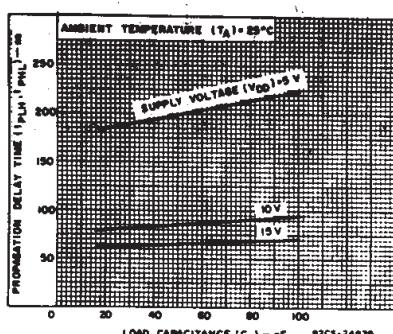
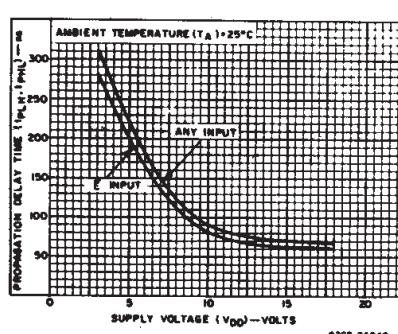
LOGIC 1 ≡ HIGH
LOGIC 0 ≡ LOWFig. 8 – Typical propagation delay time vs. load capacitance (\bar{E} input to any output).

Fig. 9 – Typical propagation delay time vs. supply voltage.

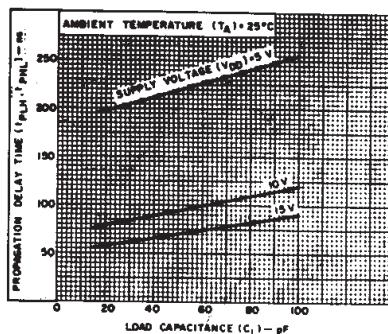


Fig. 7 – Typical propagation delay time vs. load capacitance (A or B input to any output).

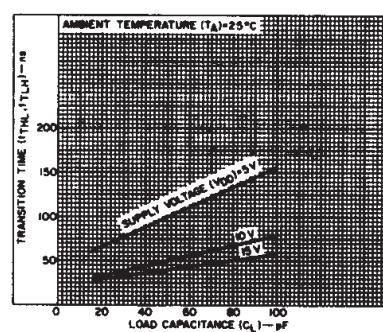


Fig. 10 – Typical transition time vs. load capacitance.

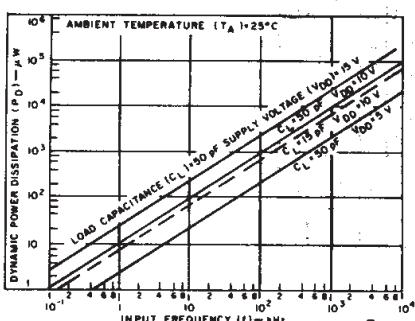


Fig. 11 – Typical dynamic power dissipation vs. frequency.

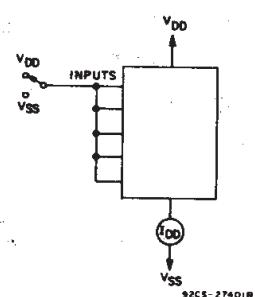


Fig. 12 – Quiescent device current test circuit.

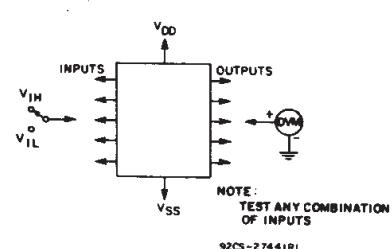


Fig. 13 – Input voltage test circuit.

CD4555B, CD4556B Types

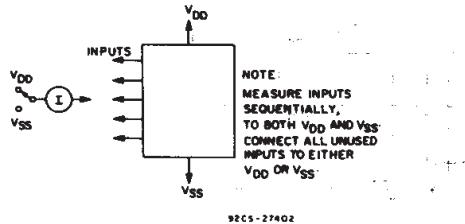


Fig. 14 – Input current test circuit.

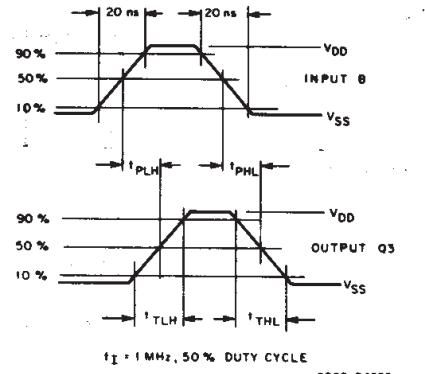


Fig. 15 – CD4555B B input to Q3 output dynamic signal waveforms.

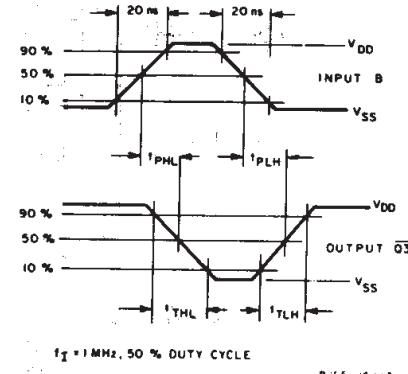


Fig. 16 – CD4556B B input to Q̄3 output dynamic signal waveforms.

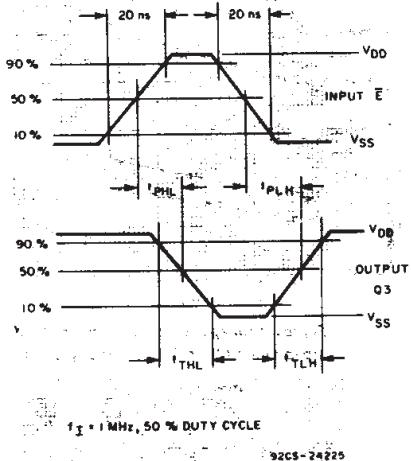


Fig. 17 – CD4555B Ē input to Q3 output dynamic signal waveforms.

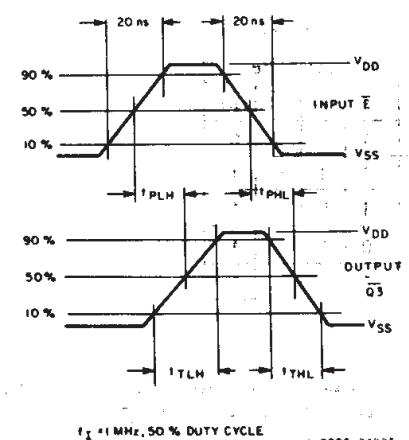
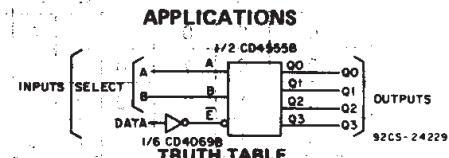


Fig. 18 – CD4556B Ē input to Q̄3 output dynamic signal waveforms.



SELECT INPUTS	OUTPUTS
B A	Q0 Q1 Q2 Q3
0 0	DATA 0 0 0
0 1	0 DATA 0 0
1 0	0 0 DATA 0
1 1	0 0 0 DATA

Fig. 19 – 1-of-4 line data demultiplexer using CD4555B.

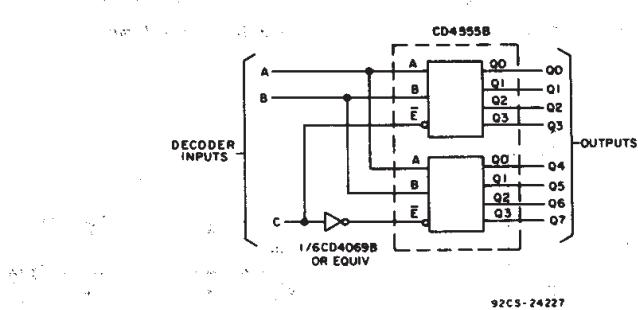


Fig. 20 – 1-of-8 decoder using CD4555B.

INPUTS	Q OUTPUTS
C B A 0 1 2 3 4 5 6 7	Q0 Q1 Q2 Q3 Q4 Q5 Q6 Q7
0 0 0 1 0 0 0 0 0 0 0	0 0 0 1 0 0 0 0 0 0
0 0 1 0 1 0 0 0 0 0 0	0 1 1 0 0 0 1 0 0 0
0 1 0 0 0 1 0 0 0 0 0	0 1 1 0 0 0 0 1 0 0
0 1 1 0 0 0 1 0 0 0 0	1 0 0 0 0 0 0 1 0 0
1 0 0 0 0 0 0 1 0 0 0	1 0 1 0 0 0 0 0 1 0
1 0 1 0 0 0 0 0 1 0 0	1 1 0 0 0 0 0 0 1 0
1 1 0 0 0 0 0 0 1 0 0	1 1 1 0 0 0 0 0 0 1

CD4555B, CD4556B Types

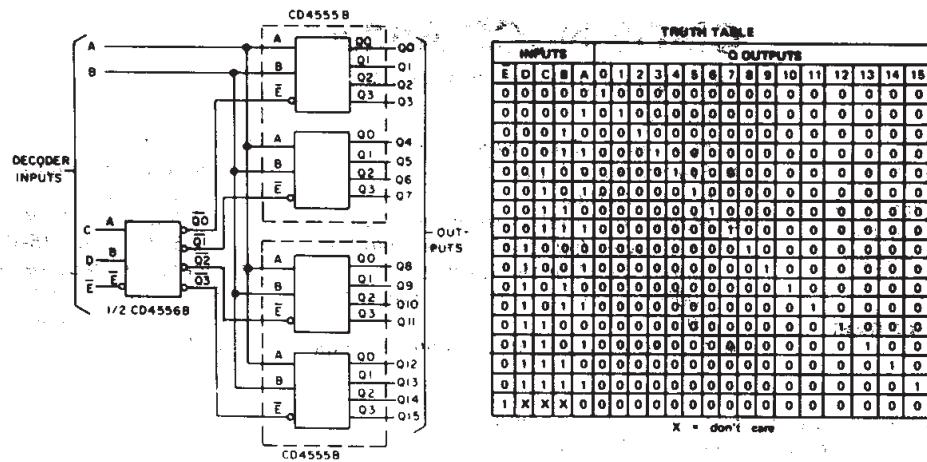
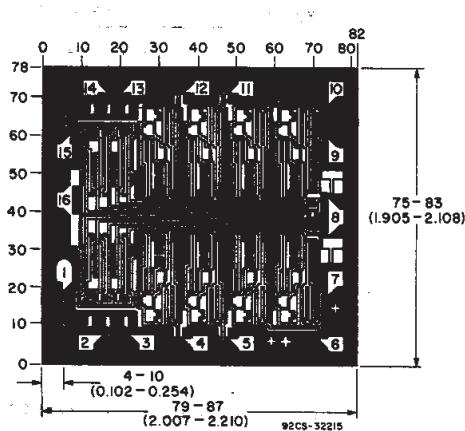
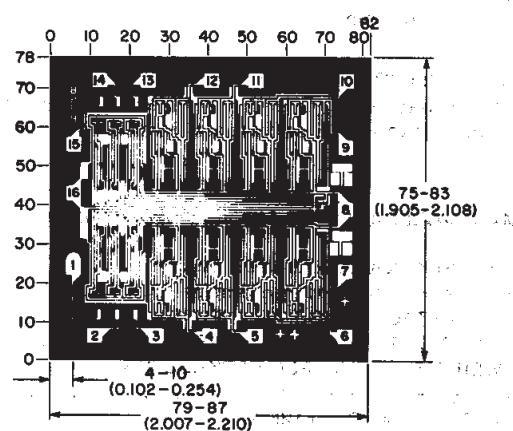


Fig. 21 – 1-of-16 decoder using CD4555B and CD4556B.



DIMENSIONS AND PAD LAYOUT FOR CD4555BH.

Dimensions in parentheses are in millimeters and are derived from the basic inch dimensions as indicated. Grid graduations are in mils (10^{-3} inch).



DIMENSIONS AND PAD LAYOUT FOR CD4556BH.

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